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# NB7HQ14M

## 2.5V 7GHz / 10Gbps Differential Input to 1.8V / 2.5V 1:4 CML Clock / Data Fanout Buffer w/ Selectable Input Equalizer

### Multi-Level Inputs w/ Internal Termination

#### Description

The NB7HQ14M is a high performance differential 1:4 CML fanout buffer with a selectable Equalizer receiver. When placed in series with a Clock /Data path operating up to 7 GHz or 10 Gb/s, respectively, the NB7HQ14M inputs will compensate the degraded signal transmitted across a FR4 PCB backplane or cable interconnect and output four identical CML copies of the input signal. Therefore, the serial data rate is increased by reducing Inter-Symbol Interference (ISI) caused by losses in copper interconnect or long cables. The Equalizer ENable pin (EQEN) allows the IN/IN inputs to either flow through or bypass the Equalizer section. Control of the Equalizer function is realized by setting EQEN; When EQEN is set Low, the IN/IN inputs bypass the Equalizer. When EQEN is set High, the IN/IN inputs flow through the Equalizer. The default state at start-up is LOW. As such, NB7HQ14M is ideal for SONET, GigE, Fiber Channel, Backplane and other Clock/Data distribution applications.

The differential inputs incorporate internal 50  $\Omega$  termination resistors that are accessed through the VT pin. This feature allows the NB7HQ14M to accept various logic level standards, such as LVPECL, CML or LVDS. The outputs have the flexibility of being powered by either a 2.5 V or 1.8 V supply. The 1:4 fanout design was optimized for low output skew applications.

The NB7HQ14M is a member of the GigaComm™ family of high performance clock products.

#### Features

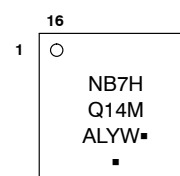
- Input Data Rate > 10 Gb/s
- Input Clock Frequency > 7 GHz
- 150 ps Typical Propagation Delay
- 35 ps Typical Rise and Fall Times
- < 15 ps Maximum Output Skew
- < 0.8 ps Maximum RMS Clock Jitter
- < 10 ps pp of Data Dependent Jitter
- Differential CML Outputs, 400 mV Peak-to-Peak, Typical
- Selectable Input Equalization
- Operating Range:  $V_{CC} = 2.375$  V to 2.625 V,  $V_{CCO} = 1.71$  V to 2.625 V
- Internal Input Termination Resistors, 50  $\Omega$
- -40°C to +85°C Ambient Operating Temperature
- These are Pb-Free Devices



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#### MARKING DIAGRAM\*

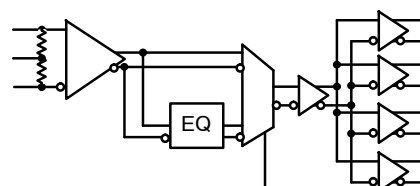


|   |                     |
|---|---------------------|
| A | = Assembly Location |
| L | = Wafer Lot         |
| Y | = Year              |
| W | = Work Week         |
| ▪ | = Pb-Free Package   |

(Note: Microdot may be in either location)

\*For additional marking information, refer to Application Note AND8002/D.

#### SIMPLIFIED BLOCK DIAGRAM



#### ORDERING INFORMATION

See detailed ordering and shipping information in the package dimensions section on page 9 of this data sheet.

## NB7HQ14M

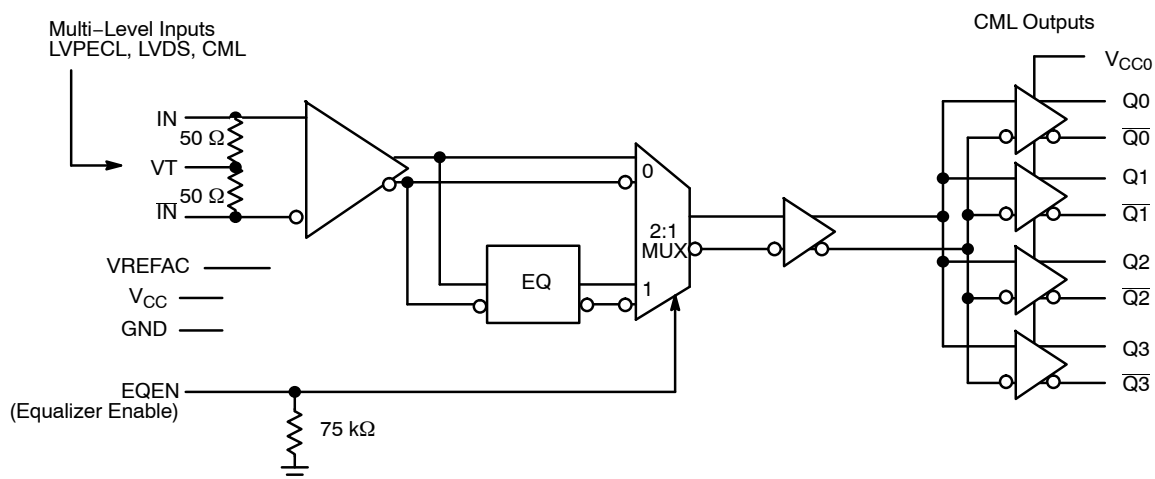
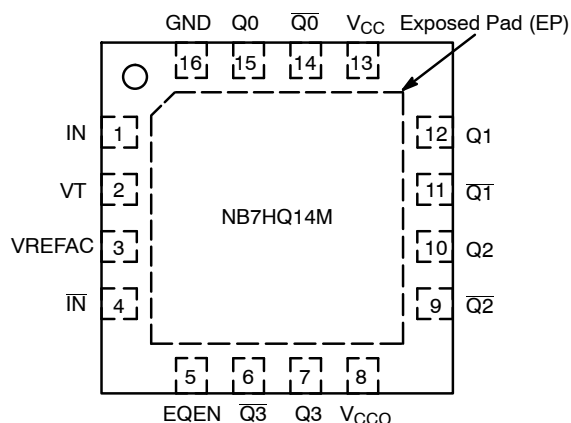


Figure 1. Detailed Block Diagram of NB7HQ14M

## NB7HQ14M



**Table 1. EQUALIZER ENABLE FUNCTION**

| EQEN | Function   |
|------|--|
| 0    | IN / $\overline{\text{IN}}$ Inputs By-pass the Equalizer section |
| 1    | Inputs flow through the Equalizer                                |

**Figure 2. QFN-16 Pinout (Top View)**

**Table 2. PIN DESCRIPTION**

| Pin | Name                   | I/O                     | Description   |
|-----|------------------------|-------------------------|---|
| 1   | IN                     | LVPECL, CML, LVDS Input | Non-inverted Differential Input. Note 1.  |
| 2   | VT                     |                         | Internal 100 $\Omega$ Center-tapped Termination Pin for IN / $\overline{\text{IN}}$   |
| 3   | VREFAC                 |                         | Output Voltage Reference for Capacitor-Coupled Inputs, only   |
| 4   | $\overline{\text{IN}}$ | LVPECL, CML, LVDS Input | Inverted Differential Input. Note 1.  |
| 5   | EQEN                   | LVC MOS Input           | Equalizer Enable Input; pin will default LOW when left open (has internal pull-down resistor)   |
| 6   | $\overline{\text{Q3}}$ | CML Output              | Inverted Differential Output. Typically Terminated with 50 $\Omega$ Resistor to $V_{\text{CC}}$ .   |
| 7   | Q3                     | CML Output              | Non-inverted Differential Output. Typically Terminated with 50 $\Omega$ Resistor to $V_{\text{CC}}$ .   |
| 8   | VCCO                   | –                       | 1.8 V or 2.5 V Positive Supply Voltage for the Qn / $\overline{\text{Qn}}$ CML Outputs  |
| 9   | $\overline{\text{Q2}}$ | CML Output              | Inverted Differential Output. Typically Terminated with 50 $\Omega$ Resistor to $V_{\text{CC}}$ .   |
| 10  | Q2                     | CML Output              | Non-inverted Differential Output. Typically Terminated with 50 $\Omega$ Resistor to $V_{\text{CC}}$ .   |
| 11  | $\overline{\text{Q1}}$ | CML Output              | Inverted Differential Output. Typically Terminated with 50 $\Omega$ Resistor to $V_{\text{CC}}$ .   |
| 12  | Q1                     | CML Output              | Non-inverted Differential Output. Typically Terminated with 50 $\Omega$ Resistor to $V_{\text{CC}}$ .   |
| 13  | VCC                    | –                       | 2.5 V Positive Supply Voltage for the core  |
| 14  | $\overline{\text{Q0}}$ | CML Output              | Inverted Differential Output. Typically Terminated with 50 $\Omega$ Resistor to $V_{\text{CC}}$ .   |
| 15  | Q0                     | CML Output              | Non-inverted Differential Output. Typically Terminated with 50 $\Omega$ Resistor to $V_{\text{CC}}$ .   |
| 16  | GND                    | –                       | Negative Supply Voltage   |
| –   | EP                     | –                       | The Exposed Pad (EP) on the QFN-16 package bottom is thermally connected to the die for improved heat transfer out of package. The exposed pad must be attached to a heat-sinking conduit. The pad is electrically connected to the die, and must be electrically and thermally connected to GND on the PC board. |

1. In the differential configuration when the input termination pin (VT) is connected to a common termination voltage or left open, and if no signal is applied on IN /  $\overline{\text{IN}}$  input, then, the device will be susceptible to self-oscillation.
2. All VCC, VCCO and GND pins must be externally connected to a power supply for proper operation.

## NB7HQ14M

**Table 3. ATTRIBUTES**

| Characteristics  |                                   | Value                |
|--|-----------------------------------|----------------------|
| ESD Protection   | Human Body Model<br>Machine Model | > 2 kV<br>> 200V     |
| R <sub>PD</sub> – EQEN Input Pulldown Resistor         |                                   | 75 kΩ                |
| Moisture Sensitivity (Note 3)                          | 16–QFN                            | Level 1              |
| Flammability Rating                                    | Oxygen Index: 28 to 34            | UL 94 V–0 @ 0.125 in |
| Transistor Count                                       |                                   | 290                  |
| Meets or exceeds JEDEC Spec EIA/JESD78 IC Latchup Test |                                   |                      |

3. For additional information, see Application Note AND8003/D.

**Table 4. MAXIMUM RATINGS**

| Symbol              | Parameter   | Condition 1        | Condition 2      | Rating                        | Unit         |
|---------------------|---|--------------------|------------------|-------------------------------|--------------|
| V <sub>CC</sub>     | Positive Power Supply – Core                                | GND = 0 V          |                  | 3.0                           | V            |
| V <sub>CCO</sub>    | Positive Power Supply – Outputs                             | GND = 0 V          |                  | 3.0                           | V            |
| V <sub>IO</sub>     | Positive Input/Output Voltage                               | GND = 0 V          |                  | –0.5 to V <sub>CC</sub> + 0.5 | V            |
| V <sub>INPP</sub>   | Differential Input Voltage  I <sub>N</sub> – I <sub>N</sub> |                    |                  | 1.89                          | V            |
| I <sub>IN</sub>     | Input Current Through R <sub>T</sub> (50 Ω Resistor)        |                    |                  | ± 40                          | mA           |
| I <sub>OUT</sub>    | Output Current Through R <sub>T</sub> (50 Ω Resistor)       |                    |                  | ± 40                          | mA           |
| I <sub>VREFAC</sub> | VREFAC Sink/Source Current                                  |                    |                  | ± 1.5                         | mA           |
| T <sub>A</sub>      | Operating Temperature Range                                 | 16 QFN             |                  | –40 to +85                    | °C           |
| T <sub>stg</sub>    | Storage Temperature Range                                   |                    |                  | –65 to +150                   | °C           |
| θ <sub>JA</sub>     | Thermal Resistance (Junction–to–Ambient) (Note 4)           | 0 lfpm<br>500 lfpm | 16 QFN<br>16 QFN | 42<br>35                      | °C/W<br>°C/W |
| θ <sub>JC</sub>     | Thermal Resistance (Junction–to–Case) (Note 4)              |                    | 16 QFN           | 4                             | °C/W         |
| T <sub>sol</sub>    | Wave Solder<br>Pb–Free                                      |                    |                  | 265                           | °C           |

Stresses exceeding Maximum Ratings may damage the device. Maximum Ratings are stress ratings only. Functional operation above the Recommended Operating Conditions is not implied. Extended exposure to stresses above the Recommended Operating Conditions may affect device reliability.

4. JEDEC standard multilayer board – 2S2P (2 signal, 2 power) with 8 filled thermal vias under exposed pad.

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**Table 5. DC CHARACTERISTICS, MULTI-LEVEL INPUTS**  $V_{CC} = 2.375\text{ V to }2.625\text{ V}$ ;  $V_{CCO} = 1.71\text{ V to }2.625\text{ V}$ ;  $GND = 0\text{ V}$ ;  
 $T_A = -40^\circ\text{C to }85^\circ\text{C}$  (Note 5)

| Symbol | Characteristic | Min | Typ | Max | Unit |
|--------|----------------|-----|-----|-----|------|
|--------|----------------|-----|-----|-----|------|

### POWER SUPPLY / CURRENT

|                       |   |                        |                   |                        |    |
|-----------------------|---|------------------------|-------------------|------------------------|----|
| $V_{CC}$<br>$V_{CCO}$ | Power Supply Voltage<br>$V_{CC} = 2.5\text{ V}$<br>$V_{CCO} = 2.5\text{ V}$<br>$V_{CCO} = 1.8\text{ V}$                     | 2.375<br>2.375<br>1.71 | 2.5<br>2.5<br>1.8 | 2.625<br>2.625<br>1.89 | V  |
| $I_{CC}$<br>$I_{CCO}$ | Power Supply Current for $V_{CC}$ (Inputs and Outputs Open)<br>Power Supply Current for $V_{CCO}$ (Inputs and Outputs Open) |                        | 95<br>65          | 135<br>85              | mA |

### CML OUTPUTS (Note 6)

|          |   |                                 |                                 |                                 |    |
|----------|---|---------------------------------|---------------------------------|---------------------------------|----|
| $V_{OH}$ | Output HIGH Voltage<br>$V_{CCO} = 2.5\text{ V}$<br>$V_{CCO} = 1.8\text{ V}$ | $V_{CCO} - 30$<br>2470<br>1770  | $V_{CCO} - 10$<br>2490<br>1790  | $V_{CCO}$<br>2500<br>1800       | mV |
| $V_{OL}$ | Output LOW Voltage<br>$V_{CCO} = 2.5\text{ V}$<br>$V_{CCO} = 1.8\text{ V}$  | $V_{CCO} - 550$<br>1950<br>1250 | $V_{CCO} - 400$<br>2100<br>1400 | $V_{CCO} - 300$<br>2200<br>1500 | mV |

### DIFFERENTIAL INPUT DRIVEN SINGLE-ENDED (see Figure 5 & 7) (Note 7)

|           |  |                |  |                |    |
|-----------|--|----------------|--|----------------|----|
| $V_{IH}$  | Single-ended Input HIGH Voltage                            | $V_{th} + 100$ |  | $V_{CC}$       | mV |
| $V_{IL}$  | Single-ended Input LOW Voltage                             | GND            |  | $V_{th} - 100$ | mV |
| $V_{th}$  | Input Threshold Reference Voltage Range (Note 8)           | 1100           |  | $V_{CC} - 100$ | mV |
| $V_{ISE}$ | Single-ended Input Voltage Amplitude ( $V_{IH} - V_{IL}$ ) | 200            |  | 2800           | mV |

### VREFAC

|             |   |                 |                 |                |    |
|-------------|---|-----------------|-----------------|----------------|----|
| $V_{REFAC}$ | Output Reference Voltage @100 $\mu\text{A}$ for capacitor- coupled inputs, only | $V_{CC} - 1325$ | $V_{CC} - 1125$ | $V_{CC} - 925$ | mV |
|-------------|---|-----------------|-----------------|----------------|----|

### DIFFERENTIAL INPUTS DRIVEN DIFFERENTIALLY (see Figure 6 & 8) (Note 9)

|           |   |      |  |                 |               |
|-----------|---|------|--|-----------------|---------------|
| $V_{IHD}$ | Differential Input HIGH Voltage   | 1200 |  | $V_{CC}$        | mV            |
| $V_{ILD}$ | Differential Input LOW Voltage  | 0    |  | $V_{IHD} - 100$ | mV            |
| $V_{ID}$  | Differential Input Voltage ( $V_{IHD} - V_{ILD}$ )                        | 100  |  | 1200            | mV            |
| $V_{CMR}$ | Input Common Mode Range (Differential Configuration) (Note 10) (Figure 9) | 1050 |  | $V_{CC} - 50$   | mV            |
| $I_{IH}$  | Input HIGH Current $I_N / \bar{I}_N$ , (VT Open)                          | -150 |  | 150             | $\mu\text{A}$ |
| $I_{IL}$  | Input LOW Current $I_N / \bar{I}_N$ , (VT Open)                           | -150 |  | 150             | $\mu\text{A}$ |

### CONTROL INPUTS (EQEN)

|          |                                     |                      |  |                      |               |
|----------|-------------------------------------|----------------------|--|----------------------|---------------|
| $V_{IH}$ | Input HIGH Voltage for Control Pins | $V_{CC} \times 0.65$ |  | $V_{CC}$             | V             |
| $V_{IL}$ | Input LOW Voltage for Control Pins  | GND                  |  | $V_{CC} \times 0.35$ | V             |
| $I_{IH}$ | Input HIGH Current                  | -150                 |  | 150                  | $\mu\text{A}$ |
| $I_{IL}$ | Input LOW Current                   | -150                 |  | 150                  | $\mu\text{A}$ |

### TERMINATION RESISTORS

|            |                                      |    |    |    |          |
|------------|--------------------------------------|----|----|----|----------|
| $R_{TIN}$  | Internal Input Termination Resistor  | 45 | 50 | 55 | $\Omega$ |
| $R_{TOUT}$ | Internal Output Termination Resistor | 45 | 50 | 55 | $\Omega$ |

NOTE: Device will meet the specifications after thermal equilibrium has been established when mounted in a test socket or printed circuit board with maintained transverse airflow greater than 500 lfm. Electrical parameters are guaranteed only over the declared operating temperature range. Functional operation of the device exceeding these conditions is not implied. Device specification limit values are applied individually under normal operating conditions and not valid simultaneously.

5. Input parameters vary 1:1 with  $V_{CC}$ . Output parameters vary 1:1 with  $V_{CCO}$ .

6. CML outputs loaded with 50  $\Omega$  to  $V_{CCO}$  for proper operation.

7.  $V_{th}$ ,  $V_{IH}$ ,  $V_{IL}$ , and  $V_{ISE}$  parameters must be complied with simultaneously.

8.  $V_{th}$  is applied to the complementary input when operating in single-ended mode.

9.  $V_{IHD}$ ,  $V_{ILD}$ ,  $V_{ID}$  and  $V_{CMR}$  parameters must be complied with simultaneously.

10.  $V_{CMR}$  min varies 1:1 with GND,  $V_{CMR}$  max varies 1:1 with  $V_{CC}$ . The  $V_{CMR}$  range is referenced to the crosspoint side of the differential input signal.

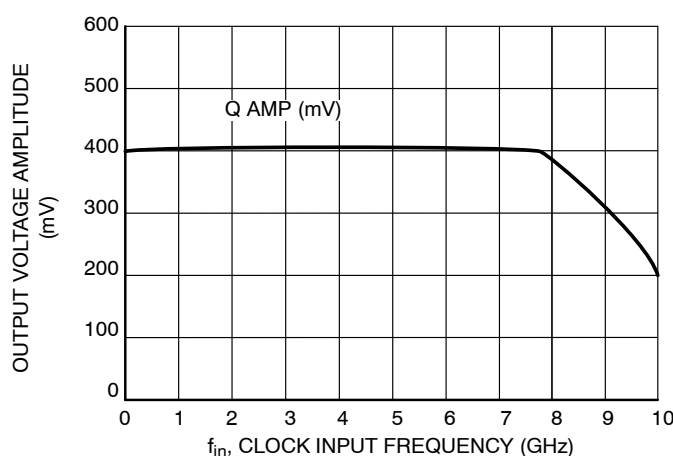
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**Table 6. AC CHARACTERISTICS**  $V_{CC} = 2.375\text{ V to }2.625\text{ V}$ ;  $V_{CCO} = 1.71\text{ V to }2.625\text{ V}$ ;  $GND = 0\text{ V}$ ;  $T_A = -40^\circ\text{C to }85^\circ\text{C}$  (Note 11)

| Symbol                   | Characteristic  | Min | Typ  | Max             | Unit                           |
|--------------------------|---|-----|--|-----------------|--------------------------------|
| $f_{MAX}$                | Maximum Input Clock Frequency; $V_{OUT} \geq 200\text{ mV}$   | 7   | 10   |                 | GHz                            |
| $f_{DATAMAX}$            | Maximum Operating Data Rate (PRBS23)  | 10  | 12   |                 | Gbps                           |
| $V_{OUTPP}$              | Output Voltage Amplitude, EQEN = 0 or 1 (Note 15) $f_{in} \leq 7\text{ GHz}$<br>(See Figure 10)   | 200 | 400  |                 | mV                             |
| $t_{PLH}$ ,<br>$t_{PHL}$ | Propagation Delay IN to Q   | 120 | 170  | 225             | ps                             |
| $t_{SKEW}$               | Duty Cycle Skew (Note 12)<br>Output – Output Within Device Skew<br>Device to Device Skew  |     | 3  | 15<br>15<br>50  | ps                             |
| $t_{DC}$                 | Output Clock Duty Cycle (Reference Duty Cycle = 50%) $f_{in} \leq 7\text{ GHz}$   | 40  | 50   | 60              | %                              |
| $\Phi_N$                 | Phase Noise, $f_{in} = 1\text{ GHz}$<br>10 kHz<br>100 kHz<br>1 MHz<br>10 MHz<br>20 MHz<br>40 MHz  |     | -135<br>-137<br>-149<br>-150<br>-150<br>-151 |                 | dBc                            |
| $t_{J\Phi N}$            | Integrated Phase Jitter $f_{in} = 1\text{ GHz}$ , 12 kHz – 20 MHz<br>Offset (RMS)   |     | 50   |                 | fs                             |
| $t_{JITTER}$             | RMS Random Clock Jitter (Note 13) $f_{in} \leq 7\text{ GHz}$<br>Peak-to-Peak Data Dependent Jitter (Note 14) $f_{in} \leq 10\text{ Gb/s}$<br>EQEN = 0 ( $\leq 3''\text{ FR4}$ )<br>EQEN = 1 ( $12''\text{ FR4}$ ) |     | 0.2  | 0.8<br>10<br>10 | ps rms<br>ps pk-pk<br>ps pk-pk |
| $V_{INPP}$               | Input Voltage Swing/Sensitivity<br>(Differential Configuration) (Note 15)   | 100 |  | 1200            | mV                             |
| $t_r$<br>$t_f$           | Output Rise/Fall Times @ 1.0 GHz $Q_x, \overline{Q_x}$<br>(20% – 80%)   | 15  | 30   | 45              | ps                             |

NOTE: Device will meet the specifications after thermal equilibrium has been established when mounted in a test socket or printed circuit board with maintained transverse airflow greater than 500 lfm. Electrical parameters are guaranteed only over the declared operating temperature range. Functional operation of the device exceeding these conditions is not implied. Device specification limit values are applied individually under normal operating conditions and not valid simultaneously.

11. Measured by forcing  $V_{INPP}$  400mV from a 50% duty cycle clock source. All loading with an external  $R_L = 50\ \Omega$  to  $V_{CCO}$ . Input edge rates 40 ps (20% – 80%).
12. Skew is measured between outputs under identical transitions and conditions @ 0.5 GHz. Duty cycle skew is measured between differential outputs using the deviations of the sum of  $T_{pw-}$  and  $T_{pw+}$  @ 0.5 GHz.
13. Additive RMS jitter with 50% duty cycle clock signal.
14. Additive peak-to-peak data dependent jitter with input NRZ data at PRBS23.
15. Input and output voltage swings are single-ended measurements operating in a differential mode.



**Figure 3. CLOCK Output Voltage Amplitude ( $V_{OUTPP}$ ) vs. Input Frequency ( $f_{in}$ ) at Ambient Temperature (Typical)**

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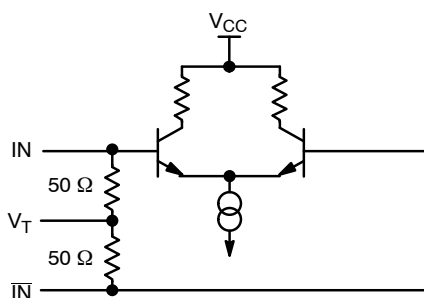


Figure 4. Input Structure

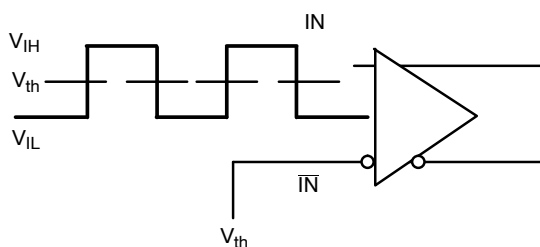


Figure 5. Differential Input Driven Single-Ended

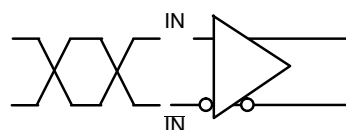


Figure 6. Differential Inputs Driven Differentially

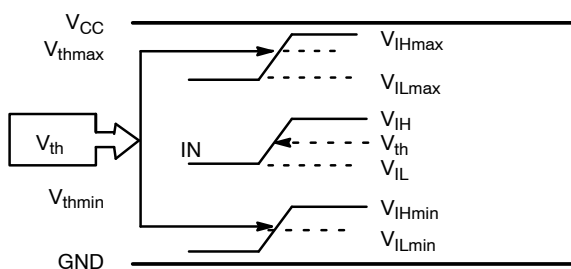


Figure 7.  $V_{th}$  Diagram

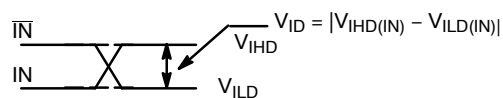


Figure 8. Differential Inputs Driven Differentially

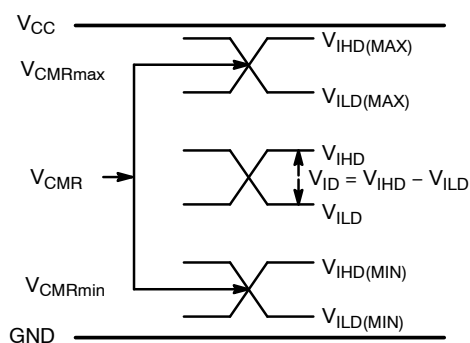


Figure 9.  $V_{CM}$  Diagram

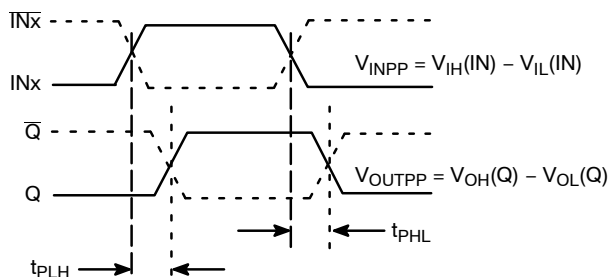
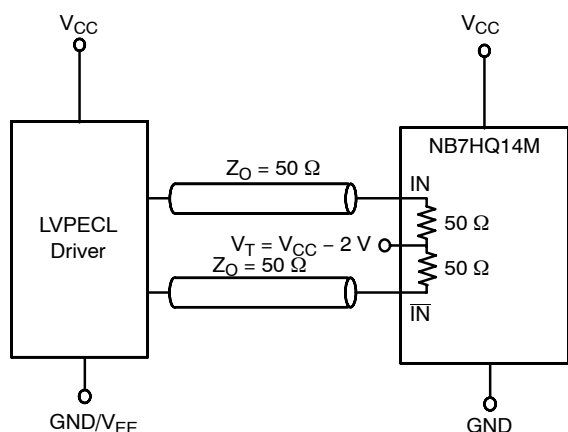


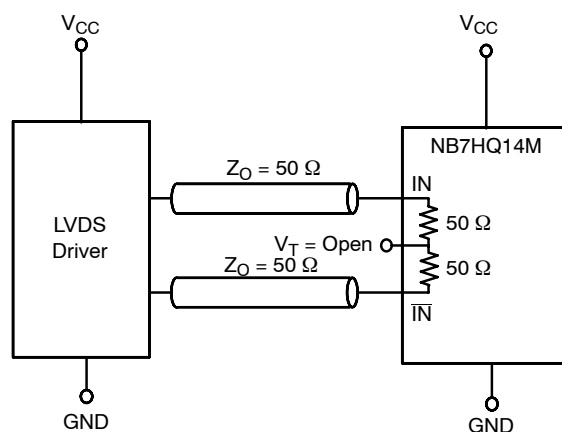
Figure 10. AC Reference Measurement



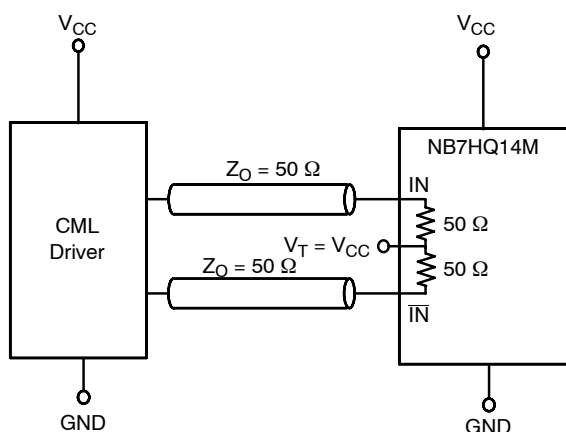
## NB7HQ14M



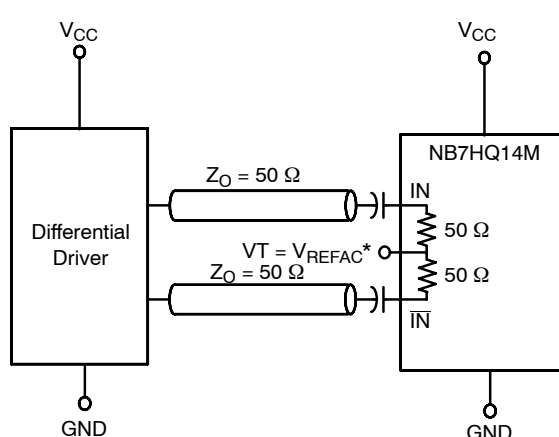
**Figure 11. LVPECL Interface**



**Figure 12. LVDS Interface**

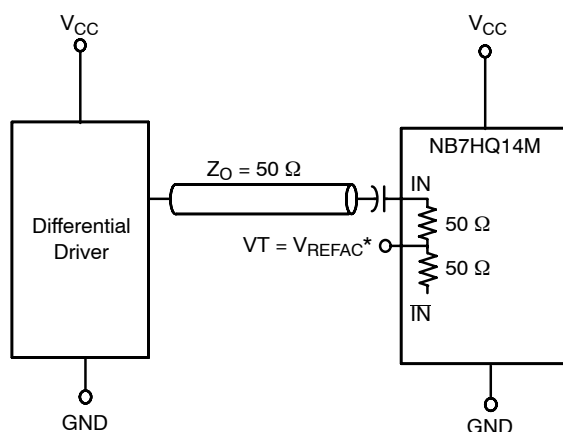


**Figure 13. Standard 50 Ω Load CML Interface**



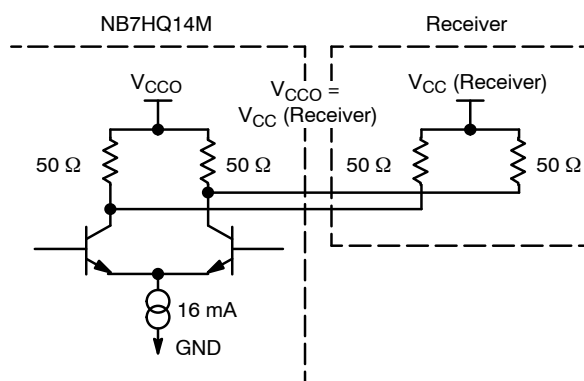
**Figure 14. Capacitor-Coupled  
Differential Interface  
( $V_T$  Connected to  $V_{REFAC}$ )**

\* $V_{REFAC}$  bypassed to ground with a 0.01  $\mu$ F capacitor

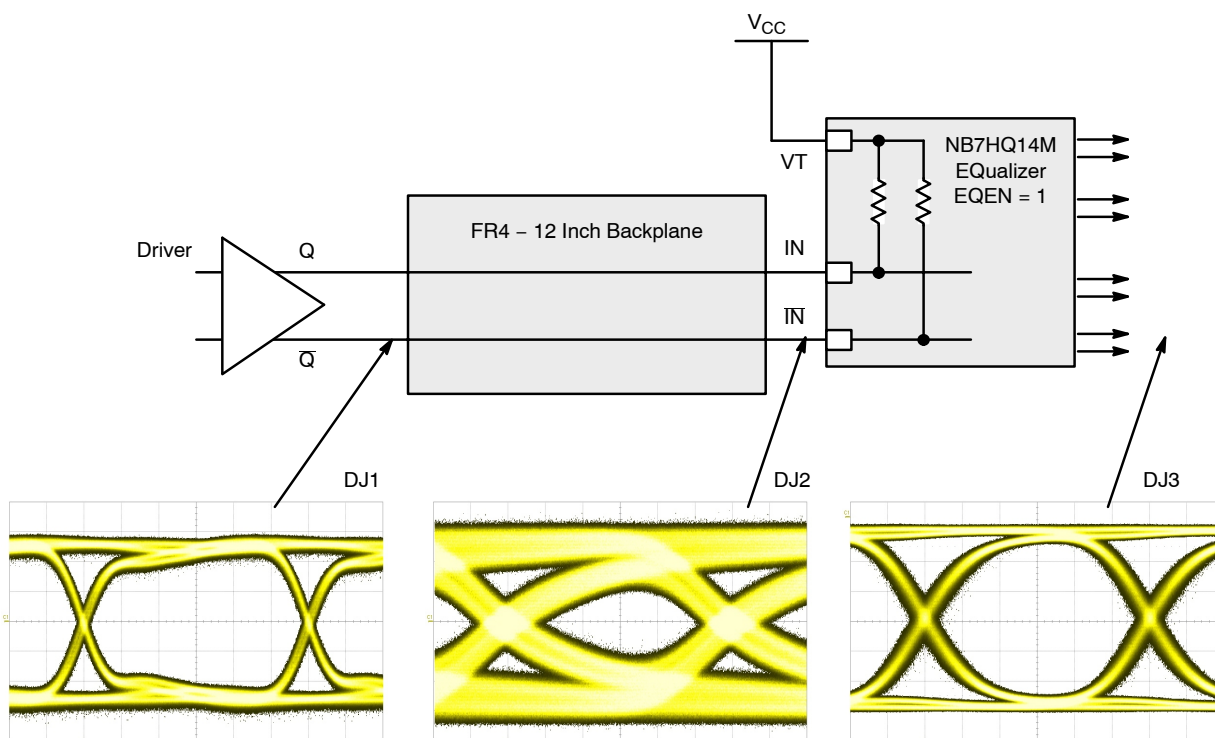


**Figure 15. Capacitor-Coupled  
Single-Ended Interface  
( $V_T$  Connected to  $V_{REFAC}$ )**

## NB7HQ14M



**Figure 16. Typical CML Output Structure and Termination**



**Figure 17. Typical NB7HQ14M Equalizer Application and Interconnect with PRBS23 pattern at 6.5 Gbps, EQEN = 1**

### ORDERING INFORMATION

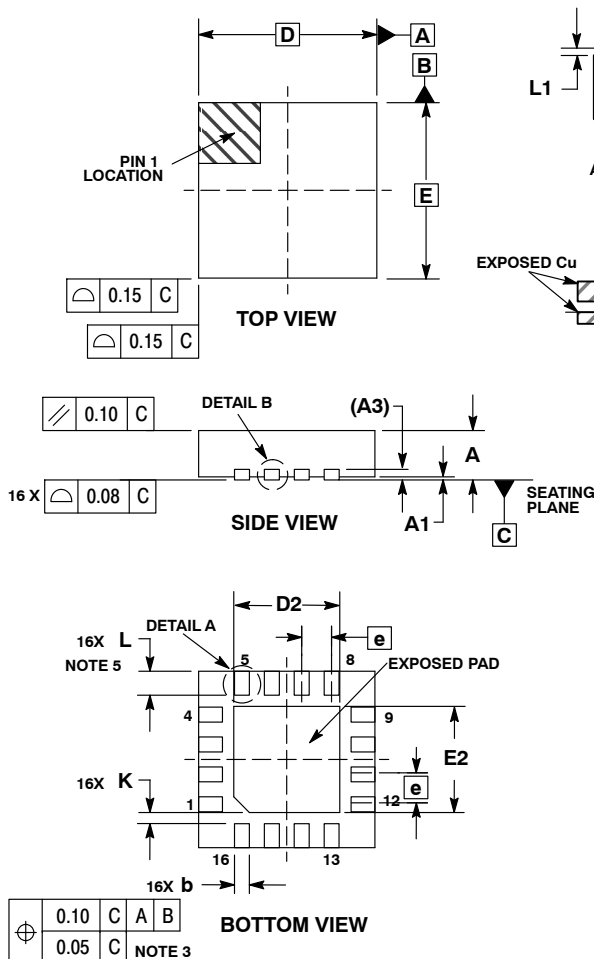
| Device         | Package             | Shipping <sup>†</sup> |
|----------------|---------------------|-----------------------|
| NB7HQ14MMNG    | QFN-16<br>(Pb-Free) | 123 Units / Rail      |
| NB7HQ14MMNHTBG | QFN-16<br>(Pb-Free) | 100 / Tape & Reel     |
| NB7HQ14MMNTXG  | QFN-16<br>(Pb-Free) | 3000 / Tape & Reel    |

<sup>†</sup>For information on tape and reel specifications, including part orientation and tape sizes, please refer to our Tape and Reel Packaging Specifications Brochure, BRD8011/D.

## NB7HQ14M

### PACKAGE DIMENSIONS

#### 16 PIN QFN CASE 485G-01 ISSUE D

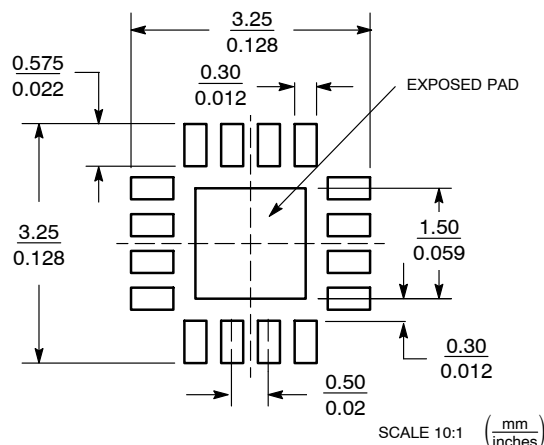


#### NOTES:

1. DIMENSIONING AND TOLERANCING PER ASME Y14.5M, 1994.
2. CONTROLLING DIMENSION: MILLIMETERS.
3. DIMENSION b APPLIES TO PLATED TERMINAL AND IS MEASURED BETWEEN 0.25 AND 0.30 MM FROM TERMINAL.
4. COPLANARITY APPLIES TO THE EXPOSED PAD AS WELL AS THE TERMINALS.
5.  $L_{max}$  CONDITION CAN NOT VIOLATE 0.2 MM MINIMUM SPACING BETWEEN LEAD TIP AND FLAG

| MILLIMETERS |      |      |
|-------------|------|------|
| DIM         | MIN  | MAX  |
| A           | 0.80 | 1.00 |
| A1          | 0.00 | 0.05 |
| A3          | 0.20 | REF  |
| b           | 0.18 | 0.30 |
| D           | 3.00 | BSC  |
| D2          | 1.65 | 1.85 |
| E           | 3.00 | BSC  |
| E2          | 1.65 | 1.85 |
| e           | 0.50 | BSC  |
| K           | 0.18 | TYP  |
| L           | 0.30 | 0.50 |
| L1          | 0.00 | 0.15 |

#### SOLDERING FOOTPRINT\*



\*For additional information on our Pb-Free strategy and soldering details, please download the ON Semiconductor Soldering and Mounting Techniques Reference Manual, SOLDERRM/D.

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